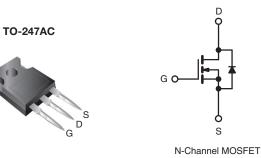


**Vishay Siliconix** 



## Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	600				
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.40			
Q <sub>g</sub> (Max.) (nC)	210				
Q <sub>gs</sub> (nC)	26				
Q <sub>gd</sub> (nC)	110				
Configuration	Single				



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC preferred package is for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPC60PbF
	SiHFPC60-E3
SnPb	IRFPC60
	SiHFPC60

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	600	v	
Gate-Source Voltage	V <sub>GS</sub>	± 20			
Continuous Drain Current	$T_{\rm C} = 25 ^{\circ}{\rm C}$		16		
	$V_{GS}$ at 10 V $T_C = 100 \degree C$	ID	10	А	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	64	1		
Linear Derating Factor			2.2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	1000	mJ		
Repetitive Avalanche Current <sup>a</sup>	I <sub>AR</sub>	16	А		
Repetitive Avalanche Energy <sup>a</sup>		E <sub>AR</sub>	28	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	PD	280	W	
Peak Diode Recovery dV/dt <sup>c</sup>		dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	*0	
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>	- °C	
Mounting Torque	6.00 or M2 corous		10	lbf ∙ in	
	6-32 or M3 screw		1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 7.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 16 A (see fig. 12).

c.  $I_{SD} \le 16$  A, dl/dt  $\le 140$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 40   0.24 -   - 0.45						
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>				°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u		1				I	1	
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static		I			1	1	1	1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	68	= 0 V, I <sub>D</sub> =	•	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	, I <sub>D</sub> = 1 mA	-	830	-	mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$		250 µA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20$		-	-	± 100	nA
Zero Gate Voltage Drain Current	Inco	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	100		
Zero date voltage Dram Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V	V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	ار	<sub>D</sub> = 9.6 A <sup>b</sup>	-	-	0.40	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> =	= 9.6 A <sup>b</sup>	13	-	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 \	1	-	3900	-	
Output Capacitance	C <sub>oss</sub>		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	440	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0  MHz, see fig. 5		-	98	-	1	
Total Gate Charge	Qg				-	-	210	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		A, V <sub>DS</sub> = 360 V, ig. 6 and 13 <sup>b</sup>	-	-	26	
Gate-Drain Charge	Q <sub>gd</sub>	-	366 1	ig. 0 and 15	-	-	110	
Turn-On Delay Time	t <sub>d(on)</sub>				-	19	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 16 A,		-	54	-	-
Turn-Off Delay Time	t <sub>d(off)</sub>	$\ddot{R}_g = 4.5 \ \Omega, \ \ddot{R}_D = 18 \ \Omega$ see fig. 10 <sup>b</sup>		-	110	-	- ns	
Fall Time	t <sub>f</sub>			-	56	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	- nH	
Internal Source Inductance	L <sub>S</sub>			-	13	-		
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol		-	-	16	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	64	A	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 16 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.8	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>				-	610	920	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 16 A, dl/dt = 100 A/μs <sup>b</sup>		-	6.6	9.9	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					· ·	

#### Notes

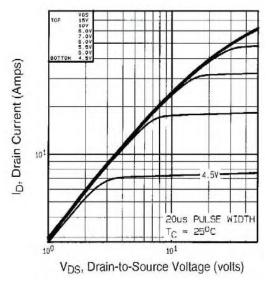
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



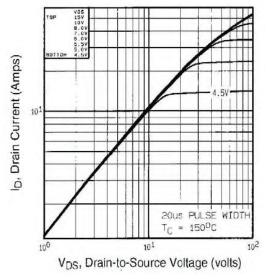


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150  $^\circ C$ 

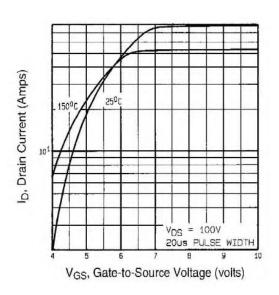


Fig. 3 - Typical Transfer Characteristics

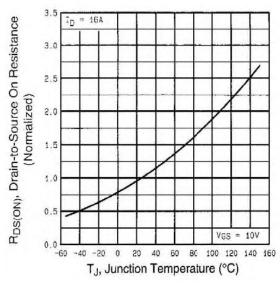


Fig. 4 - Normalized On-Resistance vs. Temperature

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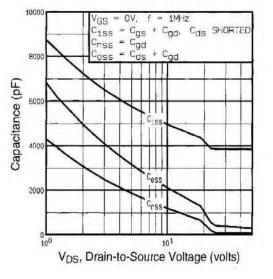
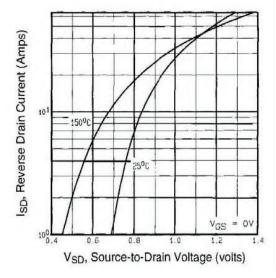
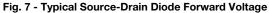


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





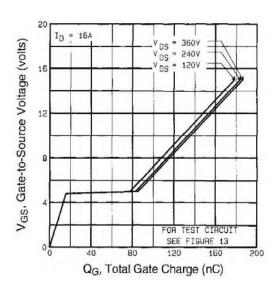


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

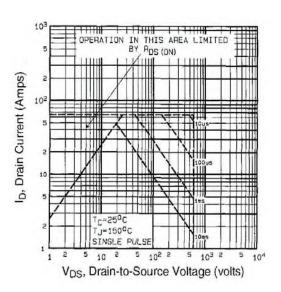


Fig. 8 - Maximum Safe Operating Area

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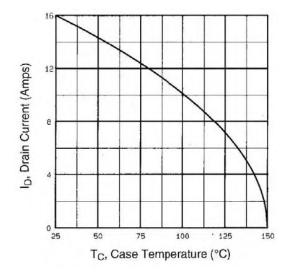


Fig. 9 - Maximum Drain Current vs. Case Temperature

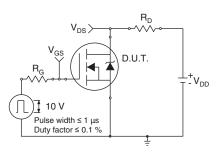


Fig. 10a - Switching Time Test Circuit

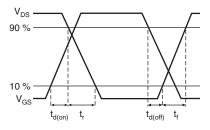


Fig. 10b - Switching Time Waveforms

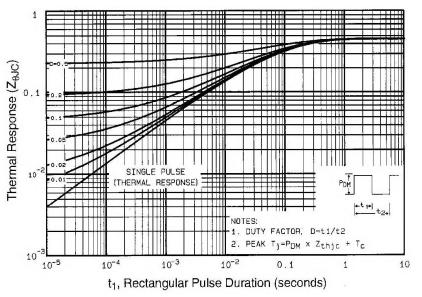


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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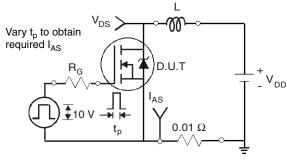


Fig. 12a - Unclamped Inductive Test Circuit

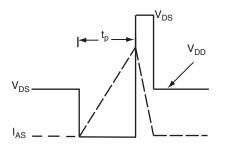


Fig. 12b - Unclamped Inductive Waveforms

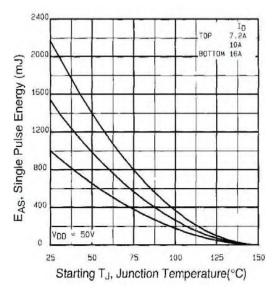
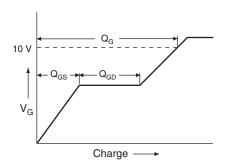


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





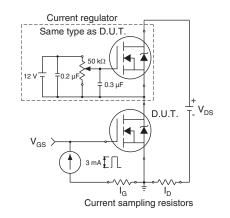
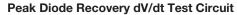


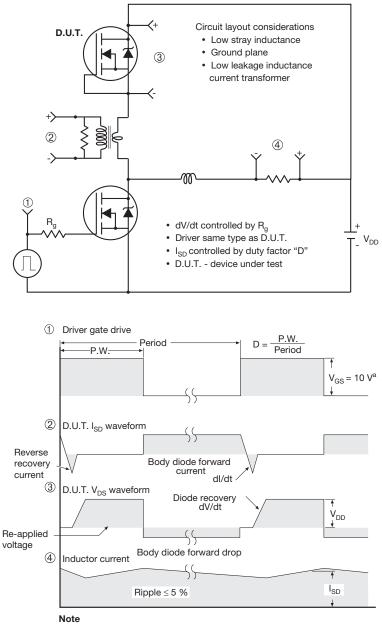
Fig. 13b - Gate Charge Test Circuit

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a.  $V_{GS} = 5$  V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91245</u>.

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## TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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